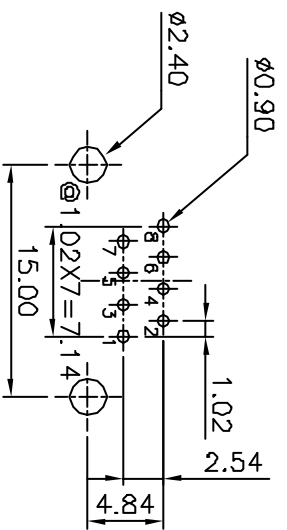
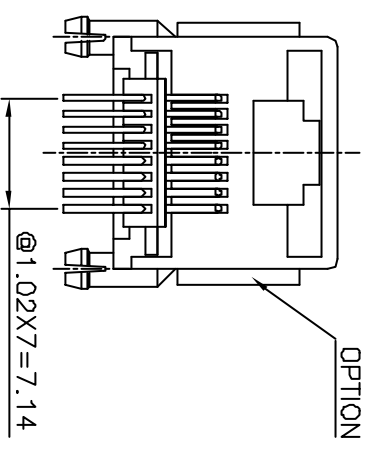
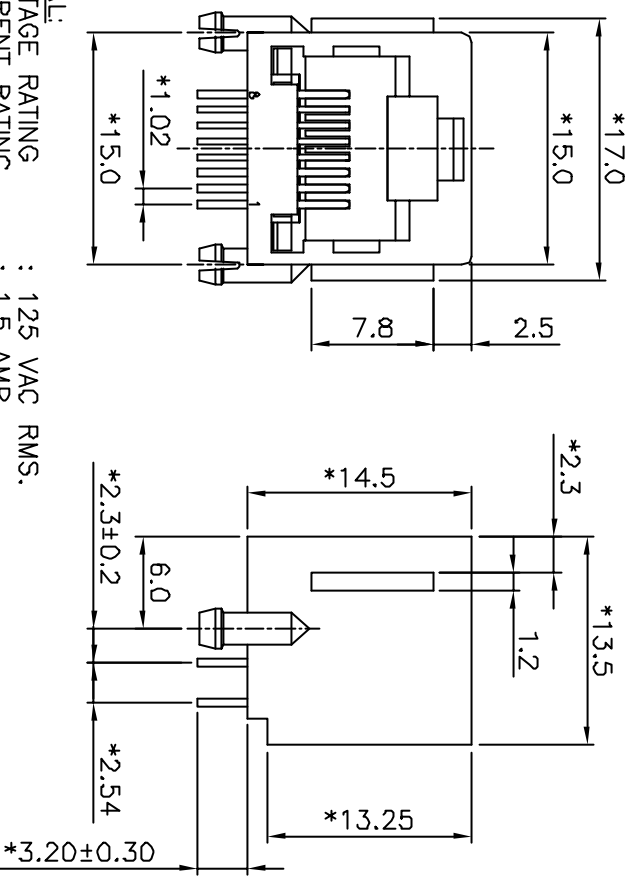


REVISION RECORD				
REV	ECO	DESCRIPTION	DFT	CHKD
△		ADD P/N	Yuan	
△		ADD P/N	Yuan	
△		ADD P/N	Yuan	
△		ADD P/N	Yuan	



PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : PBT+30%G.F UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE $\phi 0.46$ mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
 2. OPERATION: 0°C TO 70°C.
 3. WAVE SOLDERING TEMPERATURE: 230°C~250°C (5~10 SECONDS)
- MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

CUL FILE NO. E163191

ROHS PART NUMBER: E55BX-20LXXX-L

NO. OF CONTACT:

- 2-2C 4-4C
- 6-6C 8-8C

- 1-3u" 2-6u"
- 3-15u" 4-30u"
- 5-50u" 6-Pd 20u"

- △ 83-A06-2320-L W/O OPTION, COLOUR:GY (6C)
- 52-A06-1490-L W/O OPTION, COLOUR:BK
- 51-A06-1490-L W/O OPTION, COLOUR:BK
- DZ-A06-0060 W/O PANEL STOP W/O LOGO GY△

8 7 6 5 4 3 2 1

DIMENSIONS		MATERIALS		DATE		DRAWING	
MIN	MAX	DESCRIPTION	DATE	DATE	NO.	REV	SIZE
$\phi \pm 0.2$	\pm	PHOSPHOR BRONZE	2006/5/25	2006/5/25	MINI L/P SIDE ENTRY PCB JACK 8P		A3
$\phi 0 \pm 0.16$	\pm	UL94V-0 PBT	2006/5/25				3
$\phi 0 \pm 0.075$	\pm						
ANGLES ± 0.5		FINISH:		DRAWING NO. G1553003-LC		SIZE	
THIRD ANGLE PROJECTION		SCALE: 3:1		/PART NO. SEE NOTE		REV	
		DO NOT SCALE DRAWING		SHEET		OF	

FULL RISE ELECTRONIC CO., LTD

MINI L/P SIDE ENTRY PCB JACK 8P